

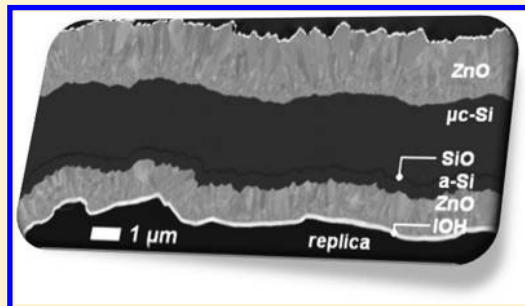
# Multiscale Transparent Electrode Architecture for Efficient Light Management and Carrier Collection in Solar Cells

Mathieu Boccard,\* Corsin Battaglia, Simon Hänni, Karin Söderström, Jordi Escarré, Sylvain Nicolay, Fanny Meillaud, Matthieu Despeisse, and Christophe Ballif

Institute of Microengineering (IMT), Photovoltaics and Thin Film Electronics Laboratory, Ecole Polytechnique Fédérale de Lausanne (EPFL), Rue A.-L. Breguet 2, CH-2000 Neuchâtel, Switzerland

## S Supporting Information

**ABSTRACT:** The challenge for all photovoltaic technologies is to maximize light absorption, to convert photons with minimal losses into electric charges, and to efficiently extract them to the electrical circuit. For thin-film solar cells, all these tasks rely heavily on the transparent front electrode. Here we present a multiscale electrode architecture that allows us to achieve efficiencies as high as 14.1% with a thin-film silicon tandem solar cell employing only 3  $\mu\text{m}$  of silicon. Our approach combines the versatility of nanoimprint lithography, the unusually high carrier mobility of hydrogenated indium oxide (over 100  $\text{cm}^2/\text{V/s}$ ), and the unequalled light-scattering properties of self-textured zinc oxide. A multiscale texture provides light trapping over a broad wavelength range while ensuring an optimum morphology for the growth of high-quality silicon layers. A conductive bilayer stack guarantees carrier extraction while minimizing parasitic absorption losses. The tunability accessible through such multiscale electrode architecture offers unprecedented possibilities to address the trade-off between cell optical and electrical performance.



**KEYWORDS:** Photovoltaics, thin-film silicon solar cells, texture, nanoimprinting, light trapping

The power of the sun (86 PW on the Earth's surface)<sup>1</sup> has the potential to solve the energy crisis of the century. By converting sunlight directly to electricity, photovoltaics has a major role to play in the energy mix of the near future, provided that the requirements of high efficiency and low cost are met simultaneously. Thin-film technologies have huge potential due to their proven low production costs<sup>2,3</sup> and their continuous efficiency increase. Fully exploiting the efficiency potential of a solar cell necessitates maximizing absorption of photons, converting them with minimal losses to electric charges, and efficiently extracting those charges to the electrical circuit. Accomplishing in an optimum way these three tasks is a common struggle faced by all photovoltaic technologies.<sup>4–6</sup>

We focus here on the transparent front electrode, which is a key element in fulfilling these three tasks. As it is the first layer of the device crossed by the incoming light, its transparency is fundamental. At the same time, it has to be sufficiently conductive to extract carriers without significant resistive losses. As conductivity is improved, transparency tends to decrease requiring a compromise to be found.<sup>6–12</sup>

In addition, especially for thin-film technologies, the front electrode has to couple light efficiently into the absorber layer and provide strong light trapping.<sup>11–18</sup> As it also serves as substrate for cell deposition, its morphology must be suitable for high-quality absorber material growth: Rugged electrode morphologies acclaimed for optimum light management generally trigger the formation of spatially inhomogeneous and porous areas in the photoactive layer. These defective areas

degrade the cell performance by lowering the potential energy of the electric charges created by absorbed light.<sup>17–20</sup>

The double trade-off on one hand between transparency and conductivity and on the other hand strong light trapping and high-quality absorber material is traditionally addressed by a single transparent conductive oxide (TCO) layer. In this letter we propose an innovative electrode architecture composed of three functional layers, which allows us to decouple these trade-offs and address them separately. By combining nanoimprint lithography and self-textured zinc oxide (ZnO), we obtain a multiscale texture that enables optimal light coupling and strong light trapping over a wide spectral range while providing ideal electrode morphology for high-quality film growth. By furthermore including a high-mobility hydrogenated indium oxide (IOH) layer in the stack, excellent transparency can be achieved while maintaining sufficient conduction for efficient carrier extraction. We validate our approach by demonstrating a thin-film silicon tandem solar cell with an absorber layer thickness of only 3  $\mu\text{m}$  and an excellent initial efficiency of 14.1%, which lies among the highest reported values for this technology.<sup>21,22</sup>

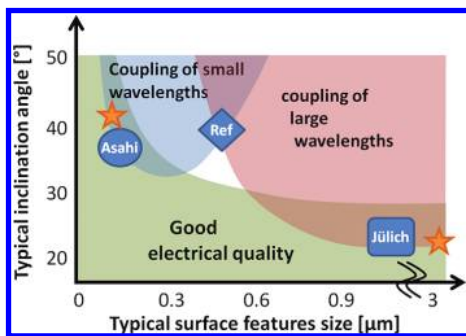
The thin-film silicon approach is very attractive due to its particularly low production costs<sup>2</sup> and use of stable, nontoxic, and abundant materials.<sup>23</sup> We focus here on the Micromorph

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concept,<sup>6</sup> which consists of a stack of hydrogenated amorphous silicon and hydrogenated microcrystalline silicon (a-Si and  $\mu$ c-Si) subcells. This tandem device structure has an efficiency potential of over 30% thanks to its ideal combination of band gaps:<sup>24</sup> a-Si efficiently absorbs visible light (of energy higher than its band gap of approximately 1.7 eV), while  $\mu$ c-Si absorbs some infrared light (down to 1.1 eV). Both materials have a low absorption coefficient close to their band gap, requiring large material thicknesses (typically a few micrometers and a few hundred micrometers, respectively) to absorb most of the light. However, due to their short carrier diffusion lengths, especially after light-induced degradation,<sup>25</sup> the thicknesses are limited to a few hundreds and a few thousands of nanometers for, respectively, a-Si and  $\mu$ c-Si subcells.<sup>26,27</sup> As the subcells are connected in series, the current flowing out of the Micromorph device will be limited by the subcell generating the lowest current. The transparent electrode substrate must therefore provide light management for both subcells, i.e., in a broad range of wavelengths (400–1100 nm). Also, the substrate morphology must be suitable for growing both high-quality a-Si and  $\mu$ c-Si material.

Figure 1 is a graphical representation of Micromorph device properties as a function of two main morphological character-

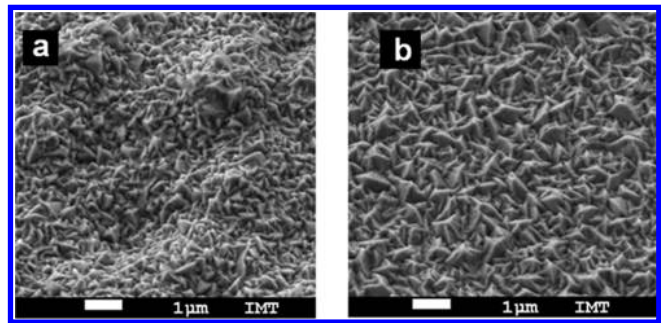


**Figure 1.** Schematic distribution of Micromorph device characteristics as a function of two main morphological properties of the substrate: the typical size of the features composing its surface and their typical inclination angle. Three state-of-the-art TCO substrates are represented: tin oxide (Asahi), sputter-etched ZnO (Jülich), and in-house LPCVD ZnO (ref). The stars correspond to the multiscale textured substrate.

istics of the substrate: The typical size of the features composing its surface, and their typical inclination angle (characterizing the sharpness of the features). Three commonly used rough TCO-based substrates are represented: textured tin oxide (Asahi),<sup>28</sup> sputter-etched zinc oxide (Jülich),<sup>11</sup> and an in-house ZnO layer deposited by low-pressure chemical vapor deposition (LPCVD) optimized for Micromorph devices (ref).<sup>29</sup>

Three main areas are sketched, corresponding to substrate morphologies favoring coupling of small wavelengths (requiring small and sharp features), scattering of large wavelengths (requiring large features), and good electrical quality (requiring small or smooth features). These areas are derived from numerous experimental data from our group<sup>29</sup> (also Supporting Information), in agreement with literature.<sup>30</sup> It is possible to combine two out of the three qualities in a single substrate, but no substrate has all three qualities. This is what we seek with the multiscale morphology corresponding to the orange stars in Figure 1, which combines small and sharp features on top of large and smooth ones. This results in a surface exhibiting a

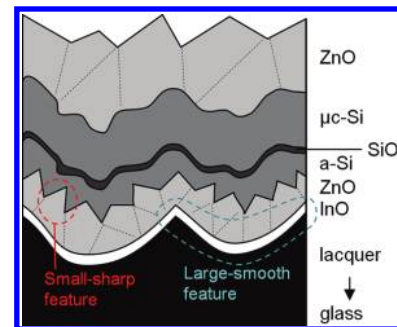
double modulation (Figure 2a), with 100 nm-scale pyramids and 3  $\mu$ m-scale hills. The two distinct textures are designed to



**Figure 2.** (a,b) SEM images of the surfaces of the multiscale textured electrode (a) and the reference ZnO electrode (b).

achieve excellent light management for short and large wavelengths. Also, both features are chosen to enable the growth of high-quality silicon material.<sup>29,31</sup>

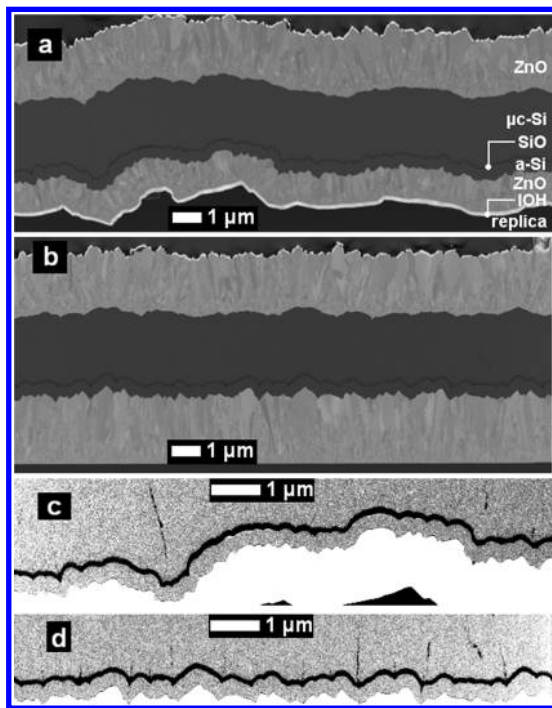
Figures 3 and 4a show a schematic drawing and a scanning electron microscopy (SEM) image of a cross section milled



**Figure 3.** Schematic drawing of a cross section of a Micromorph cell deposited on a multiscale textured substrate evidencing the small-sharp and large-smooth features.

with a focused ion beam (FIB) through a Micromorph cell deposited on this multiscale textured substrate. A smooth, micrometer-scale texture is first obtained on flat glass by replication via a high-fidelity UV-nil nanoimprint lithography technique, as detailed in ref 32. The master used here is a 16  $\mu$ m-thick LPCVD ZnO layer smoothed by a 3 h plasma treatment.<sup>33</sup> Its surface corresponds to the right-side orange star in Figure 1. Next, a 120 nm-thick IOH layer is deposited on top by sputtering as described in ref 34. Its high mobility and low carrier density ( $\mu_H > 100$  cm<sup>2</sup>/V/s and  $N_D = 1 \times 10^{20}$  cm<sup>-3</sup>) make it highly transparent for the whole wavelength range of interest for silicon solar cells for a sheet resistance ( $R_{sh}$ ) below 50  $\Omega$ .<sup>8,12</sup> Finally, a 1  $\mu$ m-thick nonintentionally doped LPCVD ZnO layer is deposited on top. Its  $R_{sh}$  of approximately 50  $\Omega$  ( $N_D = 4 \times 10^{19}$ ,  $\mu_H = 30$  cm<sup>2</sup>/V/s) makes the front electrode stack  $R_{sh}$  approximately 25  $\Omega$ , while its low carrier density keeps the electrode absorption low. This layer also offers the small but sharp features that guarantee strong light coupling into the a-Si top cell.<sup>29,35</sup> A schematic representation of the multiscale front electrode fabrication sequence with more details is available as Supporting Information.

Micromorph cells are then grown by plasma-enhanced chemical vapor deposition (PECVD) in a dual-chamber



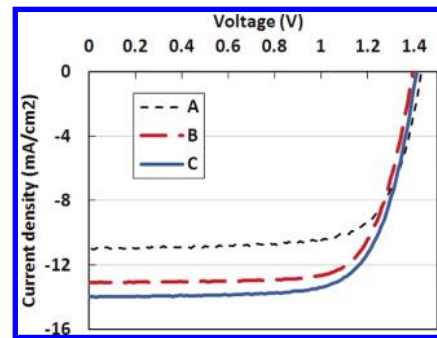
**Figure 4.** (a,b) SEM images of a FIB cut across a Micromorph cell deposited on a multiscale textured substrate (a) and on a reference ZnO layer (b). (c,d) High-contrast zoom image of (a) and (b) emphasizing bad areas (dark vertical lines) formed at the beginning of  $\mu\text{c-Si}$  growth when pinches are present at the silicon-oxide-based intermediate reflector surface due to the roughness of the front electrode.

research-scale system. The thicknesses of the intrinsic layers of the top and bottom cells are 290 nm and 2.6  $\mu\text{m}$ . A 60 nm thick silicon-oxide-based intermediate reflector<sup>36</sup> is used to reflect part of the visible light back into the top cell, enabling high top cell currents for thin layers. Doped silicon-rich silicon-oxide layers, recently developed in our laboratory, are also implemented in the bottom cell to limit the influence of inhomogeneous and low-quality silicon regions on cell performance.<sup>37,38</sup> As can be seen in Figure 3, the a-Si cell grows directly on the small and sharp texture of the ZnO layer, benefiting of its light scattering ability. These sharp features (prejudicial to good quality  $\mu\text{c-Si}$  growth) are however softened by the a-Si and SiO layers, leaving mostly a smooth and large-scale modulation at the surface of the SiO intermediate layer, ideal for good quality  $\mu\text{c-Si}$  growth and light trapping in the  $\mu\text{c-Si}$  cell.

The same Micromorph structure is also deposited on a reference flat substrate (sample A, flat glass/IOH and a thin protective ZnO layer), a state-of-the-art single-layer LPCVD ZnO electrode of which the surface is shown in Figure 2b and a cross section in Figure 4b (sample B, flat glass/2.4  $\mu\text{m}$  ZnO), and an electrode stack with only the smaller scale morphology (sample D, flat glass/IOH/1  $\mu\text{m}$  ZnO stack). A 1 min plasma surface treatment is performed on all substrates before silicon deposition. A 4 min treatment is also applied to the state-of-the-art ZnO layer to reduce the typical inclination of the surface and make it more suitable for high-quality silicon deposition.<sup>29,33</sup>

For all samples, the back contact is a lightly doped 2.4  $\mu\text{m}$ -thick LPCVD ZnO layer, and a white dielectric reflector is applied at the back of each cell.

Figure 5 presents current density–voltage ( $J(V)$ ) characteristics of the cells deposited on substrates A–C, measured with a



**Figure 5.**  $J(V)$  curves of Micromorph cells deposited on a flat substrate (A), on a reference ZnO electrode (B), and on a multiscale textured substrate (C).

dual lamp sun simulator in standard test conditions (25 °C, global air mass 1.5 (AM1.5 g) spectrum, 1000 W/m<sup>2</sup>). Table 1 summarizes their open-circuit voltages ( $V_{\text{OC}}$ ), fill factors (FF), short circuit current densities ( $J_{\text{SC}}$ ), and efficiencies.  $V_{\text{OC}}$  and FF are calculated from the  $J(V)$  characteristics of the cells, and  $J_{\text{SC}}$  of the top and bottom subcells is determined by convolution of the external quantum efficiency (EQE) and the incoming photon flux of the AM1.5 g spectrum.

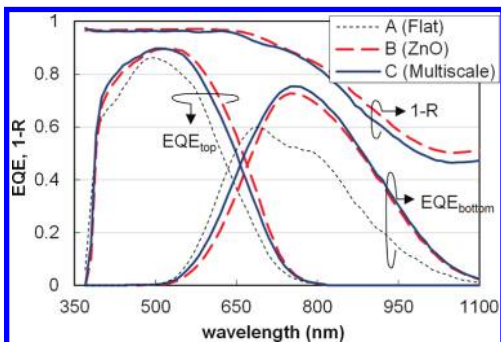
Table 1 shows that the highest initial efficiency of 14.1% is obtained on the multiscale substrate, which is a 2.8% absolute gain compared to the flat substrate and a 0.9% gain compared to the single-layer reference ZnO substrate. As can be seen in Figure 5, the efficiency gain is obtained through both  $J_{\text{SC}}$  and  $V_{\text{OC}}$  increases. This suggests that our approach allows for both better material quality and efficient light management.

Concerning the  $J_{\text{SC}}$  values, it can be seen that high top cell currents (>14 mA/cm<sup>2</sup>) can be obtained on all rough substrates, due to the particularly suitable morphology of LPCVD ZnO. However, a high bottom cell current is only achieved on the multiscale textured substrate. This can clearly be attributed to better light trapping than in samples A and D, where no large-scale texture is present to provide light scattering of large wavelengths. The comparison to the reference ZnO substrate is less straightforward, as discussed in the following. Figure 6 presents the EQE of the top and bottom subcells of devices A–C as well as total device absorption [represented as one minus the reflection from the device ( $1 - R$ )] for devices B and C.

One first notices that part of the current gain in the bottom cell for sample C compared to sample B is obtained in the 550–750 nm range. This is accompanied by a loss in the top cell and thus does not represent improved light trapping. Another striking point is that more light is actually coming out of the device on the multiscale textured electrode than on the reference ZnO substrate. As the EQE curve is higher for the multiscale textured electrode, this indicates a reduction in parasitic absorption ( $A_{\text{p}}$ ).  $A_{\text{p}}$  comes mostly from doped layers, electrodes, and back reflector in our devices.<sup>7,34</sup> As the doped layers, back electrode, and back reflector are the same in all cases, this difference can be attributed to better transparency of our multiscale textured electrode. Thus, the multiscale substrate reaches the highest summed current of the series mostly because it has better transparency, yet maintains excellent light trapping qualities.

Table 1. Characteristics of 1 cm<sup>2</sup> Micromorph Cells Grown on Various Substrates

	$V_{OC}$ (V)	FF (%)	$J_{SC, top}$ (mA/cm <sup>2</sup> )	$J_{SC, bottom}$ (mA/cm <sup>2</sup> )	$J_{SC, sum}$ (mA/cm <sup>2</sup> )	Eff. (%)
(A) flat IOH	1.432	71.8	12.6	11.0	23.6	11.3
(B) ref LPCVD ZnO	1.395	72.4	14.8	13.1	27.9	13.2
(C) multiscale texture	1.411	71.5	14.3	14.0	28.3	14.1
(D) IOH + thin LPCVD ZnO	1.420	75.0	14.5	12.6	27.1	13.4



**Figure 6.** EQE curves of top and bottom subcells of Micromorph cells deposited on a flat substrate (A), a reference ZnO substrate (B), and a multiscale textured substrate (C). Total device absorption (corresponding to  $1 - R$ ) is also plotted for B and C ( $1 - R$  is omitted for A for a better clarity).

Turning now to the  $V_{OC}$ , which is sensitive to the electrical quality of the junctions, the highest value is achieved on the flat substrate (A), as expected from Figure 1. For the reference ZnO substrate, the roughness drastically reduces the  $V_{OC}$  with a 37 mV loss caused by creation of defective areas. With the multiscale texture, the loss is reduced to only 21 mV, indicating a more homogeneous material. This correlates well with the reduced number of cracks in the  $\mu\text{c-Si}$  layer (appearing as dark lines in the cross sections in Figure 4c,d). The sharp ZnO features, mostly responsible for these cracks, are more efficiently smoothed out by the a-Si cell in the multiscale texture case than in the single-scale case, as a thinner ZnO layer (resulting in smaller features) can be used. The reductions of sheet conductance and light scattering at large wavelength are indeed compensated by, respectively, IOH and the large modulation of the replica, reproduced at the ZnO-Si interface. From the  $V_{OC}$  value observed on sample D, we can deduce that around 10 mV are still to be recovered by improving the small and large features.

Finally, the FF of tandem devices is a delicate parameter as it is strongly influenced by the difference between the subcell  $J_{SC}$ s (also called mismatch).<sup>29,39</sup> A detailed analysis of the FF changes in tandem devices is outside the scope of this work, but a few hints about our particular case follow. The lowest FF of the series is obtained for sample C, which also has the closest subcell currents. Indeed, FF gains of up to 2% per mA/cm<sup>2</sup> of mismatch are reported.<sup>29,39</sup> This explains a large part of the 3.5% FF drop between samples D and C, where the introduction of large-scale features generates a 1.6 mA/cm<sup>2</sup> mismatch reduction. The FF loss between the reference ZnO and the multiscale textured electrode can also be attributed to mismatch reduction (0.3 compared to 1.7 mA/cm<sup>2</sup>). Indeed, observing only 1% FF loss for 1.4 mA/cm<sup>2</sup> mismatch reduction suggests that better quality material is grown on the multiscale substrate. This correlates well with the  $V_{OC}$  trend and the crack densities observed in the SEM cross sections in Figure 4c,d. Thus, unlike in our earlier reports,<sup>12,40</sup> no FF losses are present due to degradation of material electrical quality or high sheet

resistances. Both issues previously faced when using nano-imprinted front electrodes are solved, with the multiscale texture and the two-layer conductive stack.

As cell efficiency is the ultimate metric, our approach exhibits strong potential by showing 14.1% initial efficiency for a thin-film silicon tandem device with only 3  $\mu\text{m}$  of absorber material. Importantly, all processes involved are compatible with large-area industrial production. This approach significantly improves flexibility when addressing the compromise between strong light scattering and high-quality material growth. It also opens new roads for light harvesting in solar cells, by splitting the spectrally wide requirements into several different dedicated photonic structures. While we restricted our study to the morphologies accessible with LPCVD ZnO, many other photonic structure combinations are possible and easily accessible thanks to the versatility of nanoimprinting that already prove many possibilities for photovoltaics applications.<sup>12,40-42</sup>

In conclusion, we proposed here a new architecture for thin-film solar cells substrates that enabled very high efficiencies to be reached with thin silicon layers. We revealed that the front electrode has numerous conflicting tasks to perform and that they can be split by using several dedicated layers. We suggested an innovative design combining three layers, each one dedicated to a specific task. A smooth and large-scale texture, fabricated in lacquer by nanoimprint lithography, ensures scattering of near-infrared light for the bottom cell while preserving a morphology suitable for high-quality silicon growth. A subsequent 1  $\mu\text{m}$ -thick, highly transparent LPCVD ZnO layer provides small and sharp features, guaranteeing coupling of ultraviolet and visible light into the top cell, again with minimal impact on silicon growth. Finally, a thin, high-mobility hydrogenated indium oxide layer ensures sufficient conductance for electrical carrier extraction without compromising transparency. Compared to state-of-the-art substrates, this new approach demonstrated similar light scattering properties together with higher transparency and better suitability for high-quality silicon growth. A noteworthy 14.1% initial efficiency was achieved, and we believe that the multiscale architecture offers unprecedented possibilities for implementing innovative photonic structures in high-efficiency low-cost thin-film solar modules.

## ■ ASSOCIATED CONTENT

### 📄 Supporting Information

Maps of the characteristics ( $V_{OC}$ ,  $J_{SC, top}$ , and  $J_{SC, bottom}$ ) of Micromorph cells as a function of the substrate features typical size and inclination. Schematic representation and description of the multiscale front electrode fabrication sequence. This material is available free of charge via the Internet at <http://pubs.acs.org>.

## ■ AUTHOR INFORMATION

### Corresponding Author

\*E-mail: [mathieu.boccard@epfl.ch](mailto:mathieu.boccard@epfl.ch).

## Notes

The authors declare no competing financial interest.

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